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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/646,806	08/25/2003		John P. Simons	20140-00263-US1	1310
30678	7590	03/16/2006		EXAM	INER
	Y BOVE	E LODGE & HUTZ	DUDA, KATHLEEN		
SUITE 800 1990 M STR	EET NW		ART UNIT	PAPER NUMBER	
WASHINGT	ON, DC	20036-3425	1756		

DATE MAILED: 03/16/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/646,806	SIMONS ET AL.					
Office Action Summary	Examiner	Art Unit					
	Kathleen Duda	1756					
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet with	h the correspondence address					
A SHORTENED STATUTORY PERIOD FOR REL WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).	B DATE OF THIS COMMUNIC t 1.136(a). In no event, however, may a re- tiod will apply and will expire SIX (6) MONT butte, cause the application to become ABA	ATION.  ply be timely filed  I'HS from the mailing date of this communication.  ANDONED (35 U.S.C. § 133).					
Status		•					
1) Responsive to communication(s) filed on 09	9 January 2006.						
2a)⊠ This action is <b>FINAL</b> . 2b)☐ T							
3) Since this application is in condition for allow	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice unde	er Ex parte Quayle, 1935 C.D.	11, 453 O.G. 213.					
Disposition of Claims							
4)⊠ Claim(s) <u>20-25</u> is/are pending in the applica	ation.						
4a) Of the above claim(s) is/are without	4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.	5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>20-25</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and	d/or election requirement.						
Application Papers							
9) ☐ The specification is objected to by the Exam	iner.						
10) The drawing(s) filed on is/are: a) a	accepted or b) objected to b	y the Examiner.					
Applicant may not request that any objection to t	the drawing(s) be held in abeyand	ce. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the cort 11) The oath or declaration is objected to by the	, ,						
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of:	ign priority under 35 U.S.C. §	119(a)-(d) or (f).					
1. Certified copies of the priority documents have been received.							
2. Certified copies of the priority documents have been received in Application No							
3. Copies of the certified copies of the p	·	•					
application from the International Bur	· · · · · · · · · · · · · · · · · · ·	· ·					
* See the attached detailed Office action for a	list of the certified copies not r	received.					
Attachment(s)	, <b>-</b>	(DTO 442)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 4) Interview Summary (PTO-413) Paper No(s)/Mail Date							
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/Paper No(s)/Mail Date		formal Patent Application (PTO-152) 					

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#### **DETAILED ACTION**

1. Claims 20-25 are pending in this application.

### Claim Rejections - 35 USC § 112

2. Claims 20-25 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. The independent claim has been amended to recite that the feature size is "less than about 0.2 microns".

The specification teaches an overcoat layer which is 0.1 to 5 microns thick and that the overcoat layer is twice as thick as the resist image. That would provide support for a resist image of 0.05 to 2.5 microns thick. There is not support for the broader recitation of "less than about 0.2 microns".

# Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

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(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

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(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 20-25 are rejected under 35 U.S.C. 102(e) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Yoon (US 2002/0155379).

The claims recite a composite structure with a substrate which is a semiconductor substrate and a resist image with a feature size less than about 0.2 microns. Youn teaches a chemically amplified resist which can be used to make semiconductor devices (paragraph 004). Paragraph 0107 teaches that the resist pattern is 0.2-0.3 microns.

Yoon does not teach all of the process claims recited but the claims are product-by-process claims which appear to be taught by Yoon.

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5. Claims 20-25 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Park (US Patent 6,369,143) or Nakano (US Patent 6,287,746).

The claims recite a composite structure with a substrate which is a semiconductor substrate and a resist image with a feature size less than about 0.2 microns.

Park teaches a resist composition which can be used in the manufacture of a semiconductor device (column 1, lines 19-33). It is taught that the composition produces patterns as small as 0.2 microns.

Nakano teaches a chemically amplified resist which can be used in making semiconductor devices (column 1, lines 15-20). It is taught in the 22<sup>nd</sup> example that a 0.2 micron pattern can be obtained.

Park and Nakano do not teach all of the process claims recited but the claims are product-by-process claims which appear to be taught by Yoon.

# Response to Arguments

6. Applicant argues that the cited patents teach a resist image as small as 0.2 microns, while the claims recite "less than about 0.2 microns. "Less than about 0,2 microns" does not distinguish from the prior art recitations.

Applicant argues the high aspect ratio which is not claimed. The claims recite a structure which comprises a substrate and an image with a feature size less than about 0.2 microns which is taught by the prior art of record.

No showing has been provided by Applicant which shows that the product as claimed differs from the prior art product.

Applicant argues that due to the high aspect ratio, the image actually has a thickness of 0.017 microns. There appears to be too much supposition to reach that conclusion since different aspect ratios can occur. In addition, this is not a claimed feature.

#### Conclusion

7. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the

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advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

8. Any inquiry concerning this communication should be directed to Examiner K. Duda at (571) 272-1383. Official FAX communications should be sent to (571) 273-8300.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark Huff, can be reached at 571-272-1385.

Information regarding the status of an application may be obtained from the Patent Application Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <a href="http://pair-direct.uspto.gov">http://pair-direct.uspto.gov</a>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Kathleen Duda Primary Examiner Art Unit 1756